PD-90396H

International **tor** Rectifier

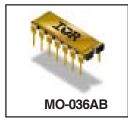
POWER MOSFET THRU-HOLE (MO-036AB)

Product Summary

Part Number	RDS(on)	ID
IRFG110	0.7 Ω	1.0A

HEXFET[®] MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

IRFG110 JANTX2N7334 JANTXV2N7334 REF:MIL-PRF-19500/597 100V, QUAD N-CHANNEL HEXFET[®] MOSFET TECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

	Parameter		Units	
ID @ VGS = 10V, TC = 25°C Continuous Drain Current		1.0		
ID @ VGS = 10V, TC = 100°C Continuous Drain Current		0.6	A	
IDM	Pulsed Drain Current ①	4.0		
PD @ TC = 25°C Max. Power Dissipation		1.4	W	
	Linear Derating Factor	0.011	W/°C	
VGS Gate-to-Source Voltage		±20	V	
EAS Single Pulse Avalanche Energy 2		75	mJ	
IAR Avalanche Current ①		1.0	A	
EAR Repetitive Avalanche Energy ①		0.14	mJ	
dv/dt Peak Diode Recovery dv/dt 3		5.5	V/ns	
ТJ	Operating Junction	-55 to 150	_	
TSTG Storage Temperature Range			°C	
	Lead Temperature	300 (0.63 in./1.6 mm from case for 10s)		
	Weight	1.3 (Typical)	g	

Absolute Maximum Ratings

For footnotes refer to the last page

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	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	100	—	—	V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	—	0.13	—	V/°C	Reference to 25°C, ID = 1.0mA
RDS(on)	Static Drain-to-Source On-State	—	—	0.7	Ω	V _{GS} = 10V, I _D = 0.6A (4)
	Resistance	—	—	0.8	52	VGS = 10V, ID = 1.0A
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
9fs	Forward Transconductance	0.86	—	—	S	V _{DS} > 15V, I _{DS} = 0.6A ④
IDSS	Zero Gate Voltage Drain Current	—	—	25	μA	VDS= 80V ,VGS=0V
		_	—	250	μΑ	V _{DS} = 80V,
						V _{GS} = 0V, T _J = 125°C
IGSS	Gate-to-Source Leakage Forward	_	—	100	- 4	V _{GS} = 20V
IGSS	Gate-to-Source Leakage Reverse	—	—	-100	nA	V _{GS} = -20V
Qg	Total Gate Charge		—	15		VGS =10V, ID = 1.0A
Qgs	Gate-to-Source Charge		_	7.5	nC	$V_{DS} = 50V$
Q _{gd}	Gate-to-Drain ('Miller') Charge	_	—	7.5	l	
td(on)	Turn-On Delay Time	—	—	20		$V_{DD} = 50V, I_D = 1.0A,$
tr	Rise Time	—	—	25		VGS =10V, RG = 7.5Ω
^t d(off)	Turn-Off Delay Time	—	—	40	ns	
tf	Fall Time	_	—	40		
LS + LD	Total Inductance		10		nH	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
C _{iss}	Input Capacitance	—	180	—		$V_{GS} = 0V, V_{DS} = 25V$
C _{OSS}	Output Capacitance		82	—] pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	—	15	—		

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current (Body D	iode)	_	—	1.0	۸	
ISM	Pulse Source Current (Body Diode)	1	_	—	4.0	A	
VSD	Diode Forward Voltage		—	—	1.5	V	$T_j = 25^{\circ}C$, $I_S = 1.0A$, $V_{GS} = 0V$ (4)
trr	Reverse Recovery Time		_	—	200	ns	Tj = 25°C, IF = 1.0A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge		—	—	0.83	μC	$V_{DD} \leq 30V @$
ton	Forward Turn-On Time Intrinsic t	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	_	17	°C/W	
R _{th} JA	Junction-to-Ambient	—	—	90	C/ VV	Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

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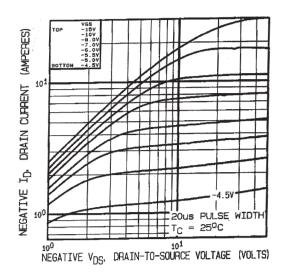


Fig 1. Typical Output Characteristics

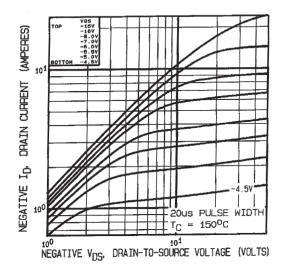


Fig 2. Typical Output Characteristics

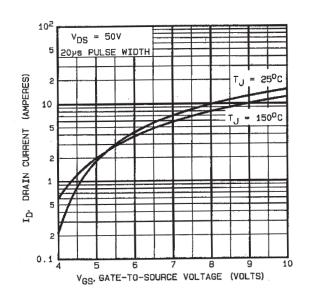


Fig 3. Typical Transfer Characteristics

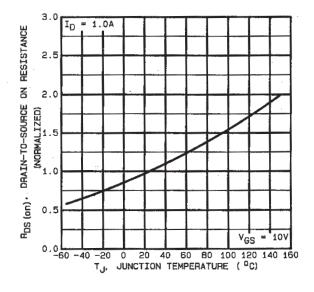


Fig 4. Normalized On-Resistance Vs. Temperature

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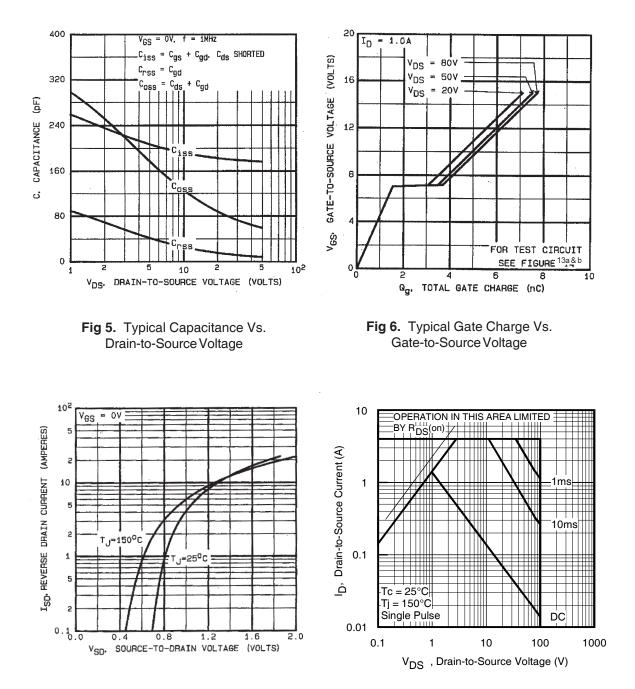
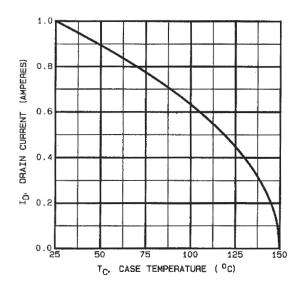


Fig 7. Typical Source-Drain Diode Forward Voltage

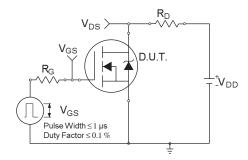
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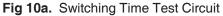
Fig 8. Maximum Safe Operating Area

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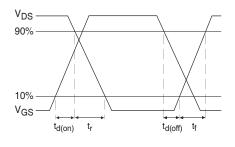


Fig 10b. Switching Time Waveforms

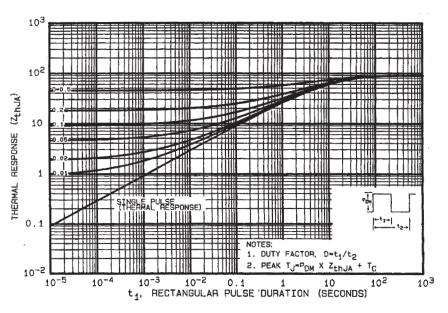


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

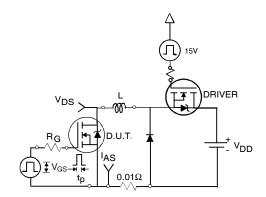


Fig 12a. Unclamped Inductive Test Circuit

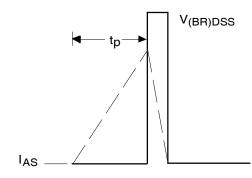


Fig 12b. Unclamped Inductive Waveforms

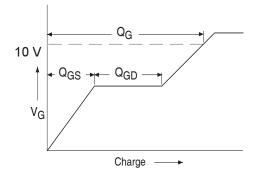


Fig 13a. Basic Gate Charge Waveform

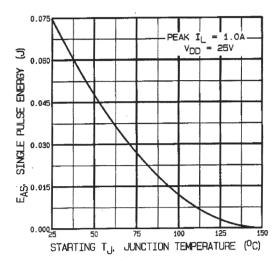


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

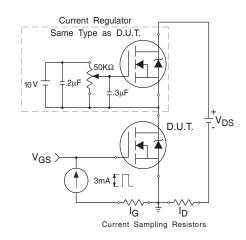


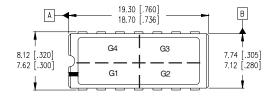
Fig 13b. Gate Charge Test Circuit

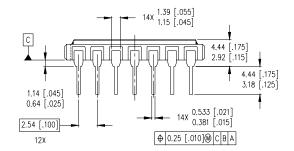
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Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $@~V_{DD}$ = 25V, starting TJ = 25°C, L= 150mH Peak IL = 1.0A, VGS = 10V
- 3 ISD \leq 1.0A, di/dt \leq 75A/ μ s,
- $V_{DD} \le 100V, T_J \le 150^{\circ}C$
- (4) Pulse width \leq 300 $\mu s;$ Duty Cycle \leq 2%

Case Outline and Dimensions — MO-036AB

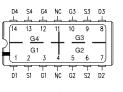


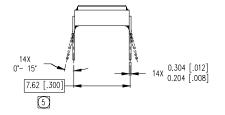


NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MO-036AB.
- (5) MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.

LEAD ASSIGNMENTS





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Data and specifications subject to change without notice. 03/2010